

# 2SK1528(L), 2SK1528(S)

# Silicon N Channel MOS FET

REJ03G0951-0200

(Previous: ADE-208-1291)

Rev.2.00 Sep 07, 2005

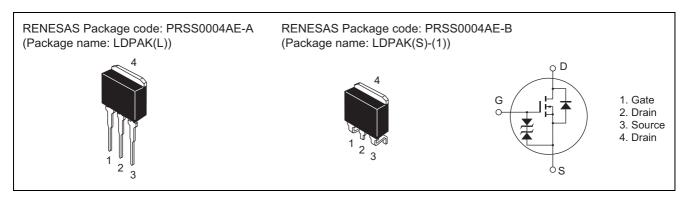
#### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

#### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	900	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	I <sub>D</sub>	4	А
Drain peak current	I <sub>D(pulse)</sub> *1	10	А
Body to drain diode reverse drain current	I <sub>DR</sub>	4	А
Channel dissipation	Pch <sup>*2</sup>	60	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at  $T_C = 25$ °C

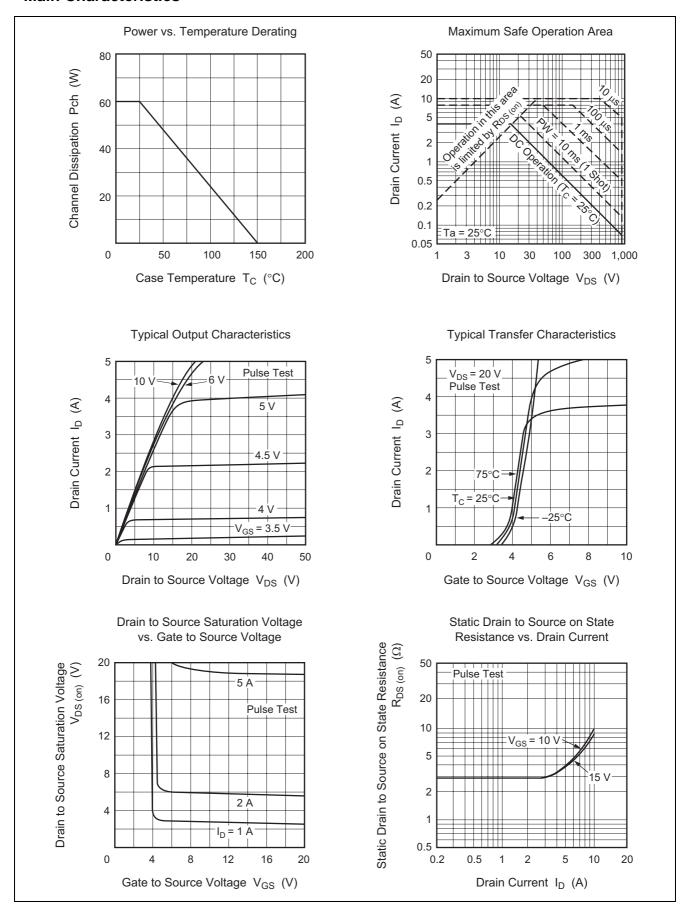
### **Electrical Characteristics**

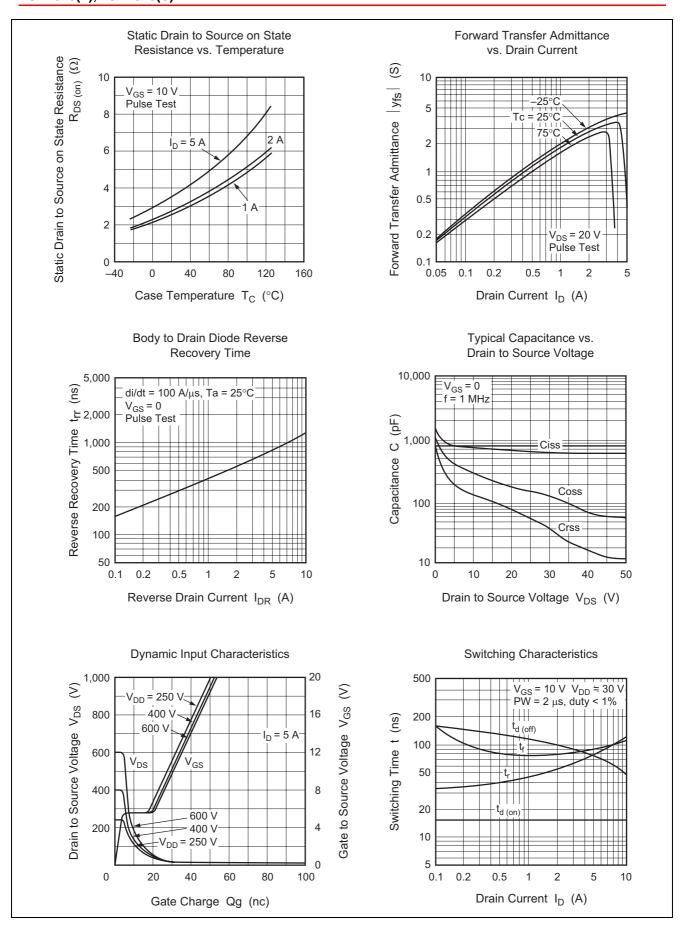
 $(Ta = 25^{\circ}C)$ 

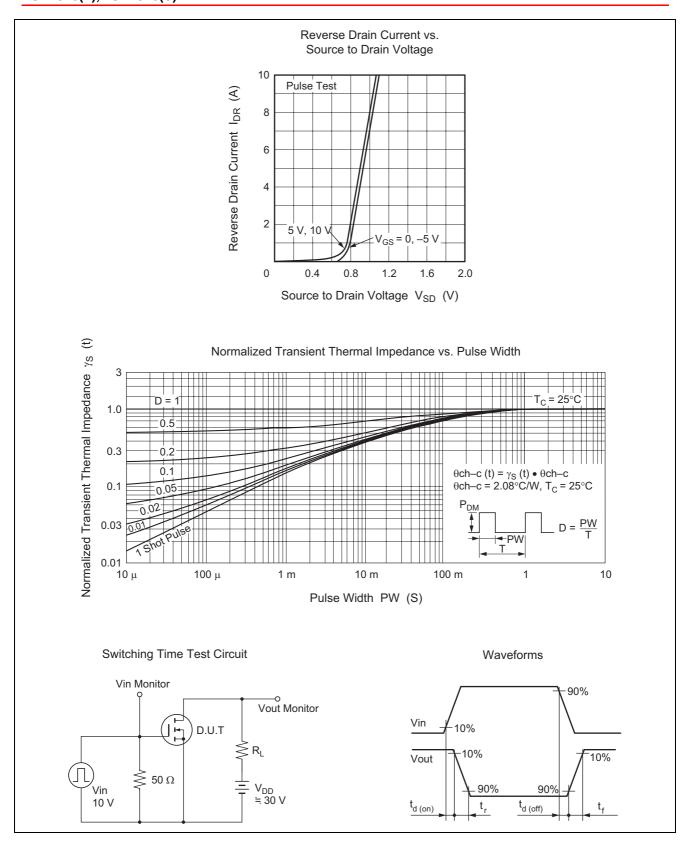
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	900	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	_	_	V	$I_G = \pm 100 \mu\text{A},  V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	250	μΑ	V <sub>DS</sub> = 720 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R <sub>DS(on)</sub>	_	3.0	4.0	Ω	$I_D = 2 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
Forward transfer admittance	y <sub>fs</sub>	1.7	2.7	_	S	$I_D = 2 \text{ A}, V_{DS} = 20 \text{ V}^{*3}$
Input capacitance	Ciss	_	740	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	305	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	150	_	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	15	_	ns	$I_D = 2 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t <sub>r</sub>	_	60	_	ns	$R_L = 15 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	100	_	ns	
Fall time	t <sub>f</sub>	_	80	_	ns	
Body to drain diode forward voltage	$V_{DF}$	_	0.9	_	V	$I_F = 4 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	800	_	ns	$I_F = 4 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Note: 3. Pulse test

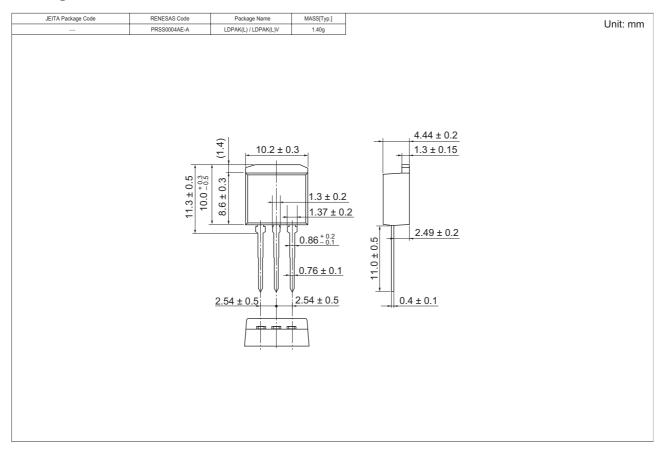
#### **Main Characteristics**

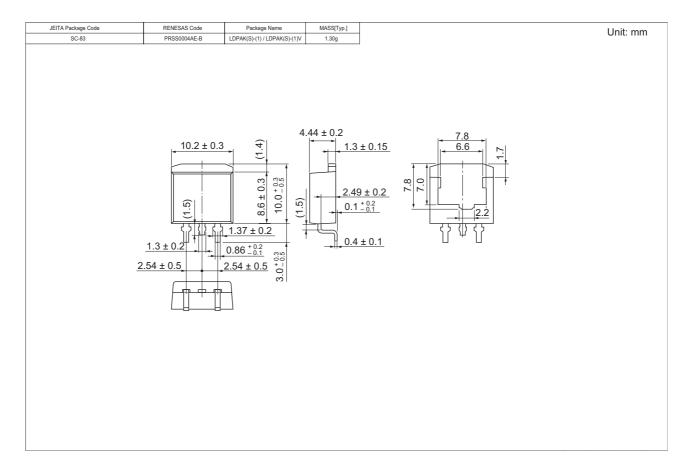






## **Package Dimensions**





# **Ordering Information**

Part Name	Quantity	Shipping Container
2SK1528L-E	500 pcs	Box (Sack)
2SK1528STL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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